Maximizing Cost Efficiencies and Productivity for AMOLED Backplane Manufacturing

Elvino da Silveira





Agenda

Introductions & Trends

Consumer products driving AMOLED Adoption!

Lithography Challenges

Devices performance <u>increase</u> <u>lithography requirements</u>

Meeting the Challenges

<u>Innovative solutions</u> to meet <u>demanding cost targets!</u>

Future Solution

Beyond lithography, process control!

Introduction

ELVINO DA SILVEIRA

Vice president of business development at Rudolph Technologies, with responsibilities to identify new markets and develop strategies to prosecute the opportunities. Until the Rudolph acquisition in December 2012, he served as president and operations manager of Azores since its inception in March 1999. Prior to forming the company, he was employed by MRS Technology, Inc., as the vice president of operations and worldwide customer support. da Silveira has also held engineering and customer support roles at Hampshire Instruments from 1991 to 1993 and GCA/General Signal from 1984 to 1991. Mr. da Silveira holds a B.S. in Mechanical Engineering from Northeastern University.





About Rudolph

Process solutions across the semiconductor industry

INSPECT

Macro Defects Silicon to Die Dicing and Chipping Detection Interconnect Metrology 3D/2D Inspection Residue Detection

CORE COMPETENCIES

MEASURE

On Product and In-die Multi-layer Film Stacks UBM, RDL, PR, PI, Dielectrics Structure CD

IMAGE

Lithography down to 2µm Fan-out and Cu Pillar Wafer and Panel

ANALYZE

Process Analysis
Process Control
Tool-centric and Fabwide



FRONT-END

BACK-END



SILICON

RUDOLPH SOLUTIONS APPLY ACROSS THE SEMICONDUCTOR VALUE CHAIN

TEST



AMOLED Trends

Increased Mobility & Function Driving New Technology Adoption

Adoption of **AMOLED**

Products driving more adoption Factors

New Form

Next generation products









OLED Materials

Flexible Substrates

Higher pixel per inch (PPI)

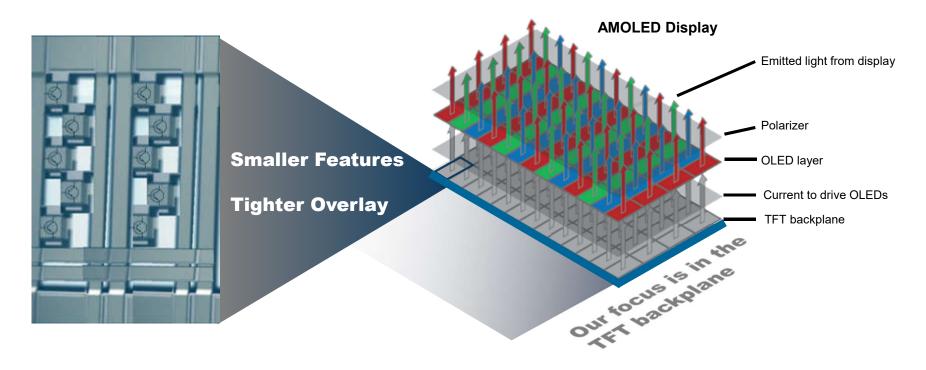
Trends Mandate Changes in Display Production Equipment

Source: IHS



AMOLED Display Overview

Backplane common to all displays



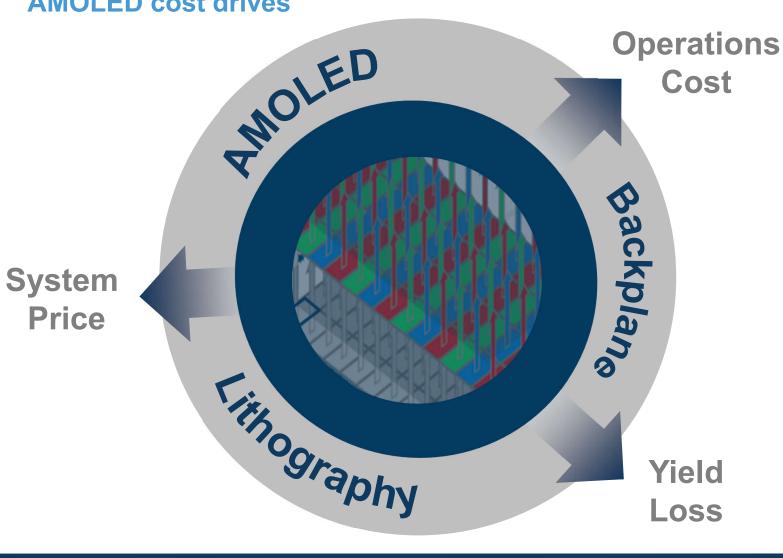
Increasing number of transistors and electrical requirements

Drive stringent lithography to meet AMOLED backplanes



Building Up the Model

AMOLED cost drives





Lithography Solution Based on innovation





Tolling Cost

GEN 6 MASK SIZE COMPARISON GRAPHIC

Glass Size: 177.6 mm x 177.6 mm

Cost: USD \$2-3k per mask

Magnification: 1.25x (enlarger)

Number of Masks per exposure: 2

GEN 6 COST COMPARISON

850 mm x 1200 mm

Cost: USD >\$30k per mask

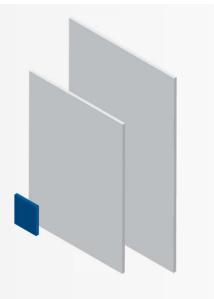
Magnification: 1:1

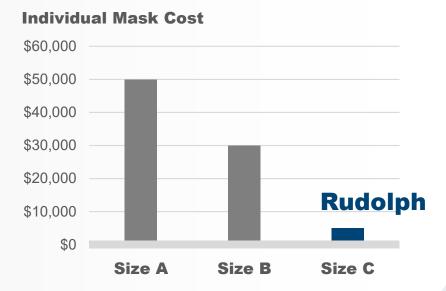
Number of Masks per Exposure: 1

Size A: 850*1200 Size B: 800*920

Rudolph

Size C: 177.6*177.6mm







Reduce Costs and Improve Utilization

Reduces Consumables Costs

No lamp replacement (est. 79K savings/year)

Reduces Operation Costs

> 21000 KW/mo and 500 CFM cleanroom air

Improves Performance

Better dose control

Increases Throughput

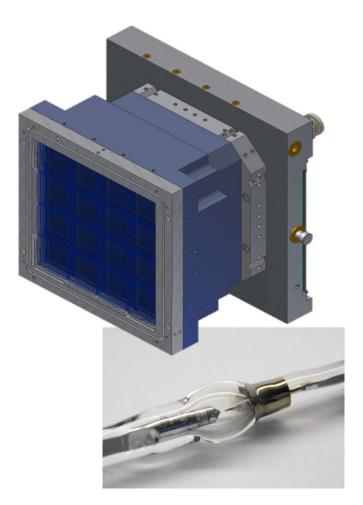
No shutter delays

Higher System Utilization

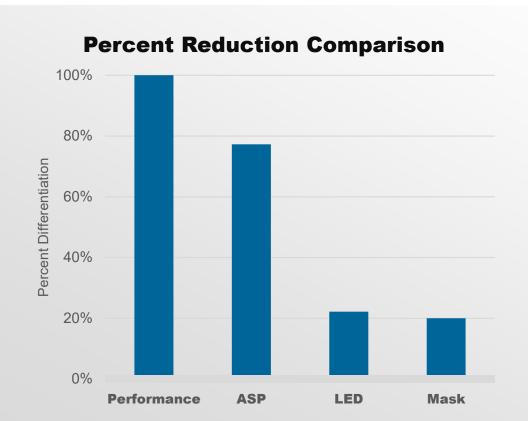
No machine down to replace lamp

Improved Reliability

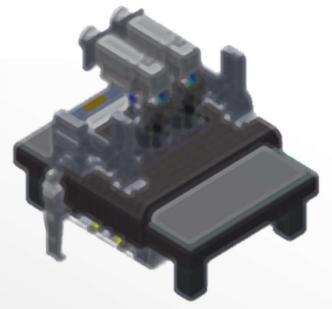
No moving parts



Lithography Cost Differentiation







Equal Performance22% Lower ASP

LED Light SourceNo High Power Hg Lamp
>70% Lower Consumable Cost

Lower Mask CostResults >5X savings per layer

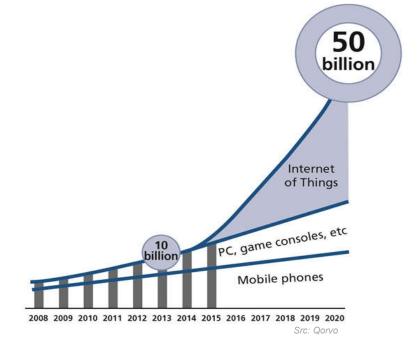
Addressing Quality in the Display Industry

Increased complexity

Higher unit counts and I/O

Strict quality-control metrics

Digital Threading enabled for rapid product diagnostics





APPLE ON THE IMPORTANCE OF QUALITY

"We started off with a very idealistic perspective-that doing something with the highest quality, doing it right the first time, would really be cheaper than have to go back and do it again"



Software Expanding Rudolph Value

Innovative software solutions contributing to Rudolph growth

Genesis™ Software



- Fast/flexible connection
- Integrated DB-many data
- Handling large data set

RUDOLPH/OEM Integration

INTELLIGENT DIAGNOSTICS Expanding across the Enterprise

ACTIONABLE INTELLIGENCE

Connected Data
End to End
Analytics

MINIMIZING RISK
CREATING VALUE



Summary

Comprehensive Solution

Accelerated Adoption of AMOLED in Mobility Products

Increased unit counts and AMOLED Adoption

Driving need for comprehensive cost containment solutions

Integrated Solutions Address

Factory Wide Monitoring and Diagnostics,

Capability to Expand into Enterprise



谢谢 | 謝謝 danke ありがとう

Thank You!

감사합니다 merci obrigado

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